onsemi

DATA SHEET www.onsemi.com

<u>MOSFET</u> – N-Channel, SUPERFET[®] II, Easy-Drive

600 V, 15 A, 260 m Ω

FCP260N60E, FCPF260N60E

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SUPERFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SUPERFET II MOSFET series.

Features

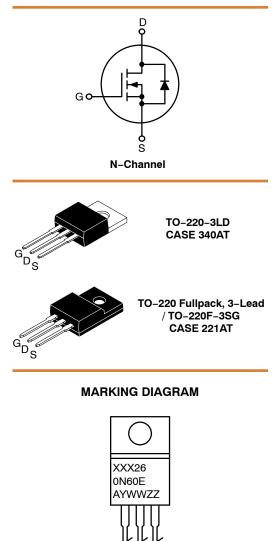
- 650 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 220 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 48 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 129 pF)
- 100% Avalanche Tested
- An Integrated Gate Resistor
- RoHS Compliant

Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

V _{DS}	R _{DS(ON)} MAX	I _D MAX	
600 V	260 mΩ @ 10 V	15 A*	

*Drain current limited by maximum junction temperature.



XXX260N60E	= Device Code (XXX = FCP, FCPF)
А	= Assembly Location
YWW	= Date Code (Year & Week)
ZZ	= Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FCP260N60E	TO-220	800 Units / Tube
FCPF260N60E	TO-220F	1000 Units / Tube

Symbol		Parameter	FCP260N60E	FCPF260N60E	Unit
V _{DSS}	Drain to Source Voltage		6	600	
V _{GSS}	Gate to Source Voltage –DC		±	V	
		–AC (f > 1 Hz)	±30		
ID	Drain Current	– Continuous (T _C = 25°C)	15	15*	Α
		– Continuous (T _C = 100°C)	9.5	9.5*	
I _{DM}	Drain Current	– Pulsed (Note 1)	45	45*	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		292.5		mJ
I _{AR}	Avalanche Current (Note 1)		3.0		Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		1.56		mJ
dv/dt	MOSFET dv/dt		100		V/ns
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T _C = 25°C)	156	36	W
		-Derate above 25°C	1.25	0.29	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range -55 to +150		o +150	°C	
ΤL	Maximum Lead Temperat 1/8" from Case for 5 Seco		300		°C

MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 3 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 7.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq \text{BV}_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

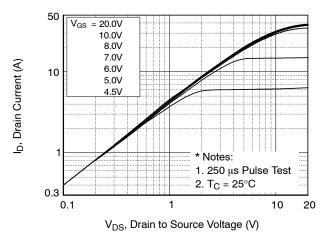
Symbol	Parameter	FCP260N60E	FCPF260N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.8	3.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

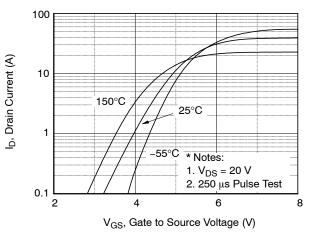
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I _D = 10 mA, T _J = 25°C	600	-	-	V
		V_{GS} = 0 V, I _D = 10 mA, T _J = 150°C	650	-	-	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25°C	-	0.67	-	V/°C
BV _{DS}	Drain to Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 15 A	-	700	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	-	1	μA
		$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	2.6	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARA	CTERISTICS					•
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2.5	_	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 7.5 A	-	0.22	0.26	Ω
9 FS	Forward Transconductance	V _{DS} = 20 V, I _D = 7.5 A	-	15.5	-	S
DYNAMIC (CHARACTERISTICS			•		
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	1880	2500	pF
C _{oss}	Output Capacitance		-	1330	1770	pF
C _{rss}	Reverse Transfer Capacitance		-	85	130	pF
Coss	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	-	32	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V} \text{ to } 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	129	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	48	62	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	7.4	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	17	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	5.8	-	Ω
SWITCHING	G CHARACTERISTICS	•				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	20	50	ns
tr	Turn-On Rise Time	R _G = 4.7 Ω (Note 4)	-	11	32	ns
t _{d(off)}	Turn-Off Delay Time		-	89	188	ns
t _f	Turn–Off Fall Time		-	13	36	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS					•
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	15	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	45	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 7.5 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I _{SD} = 7.5 A, dI _F /dt = 100 A/µs	-	270	-	ns
Q _{rr}	Reverse Recovery Charge	1	-	3.6	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS









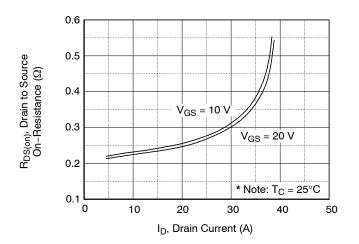


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

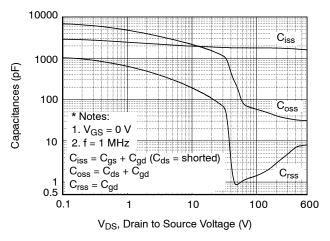


Figure 5. Capacitance Characteristics

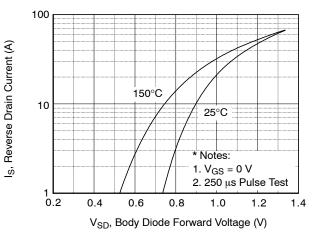


Figure 4. Body Diode Forward Voltage Variation vs. Source Current And Temperature

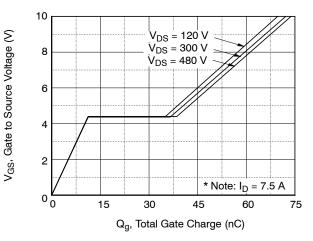
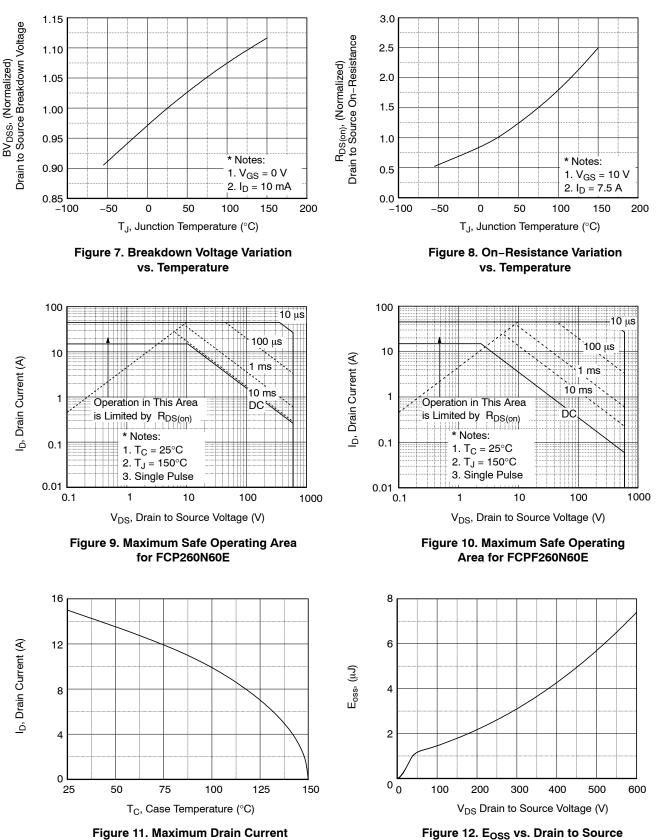


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



vs. Case Temperature

Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

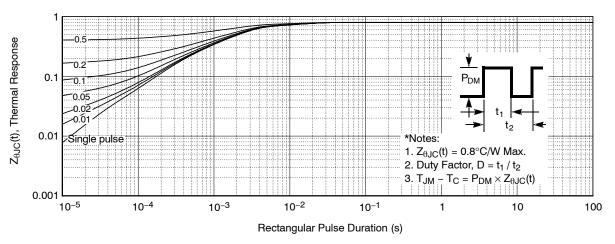


Figure 13. Transient Thermal Response Curve for FCP260N60E

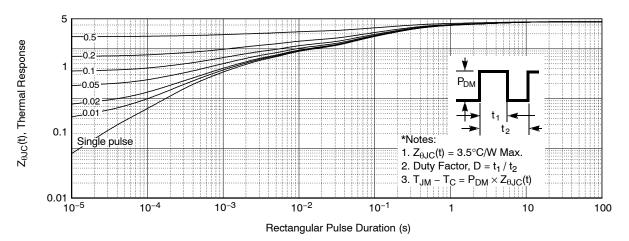
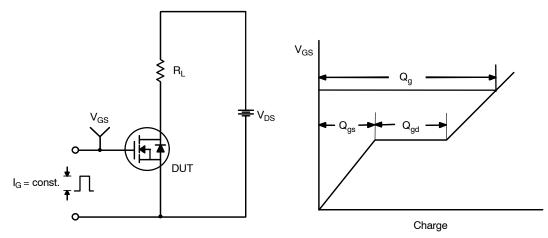


Figure 14. Transient Thermal Response Curve for FCPF260N60E





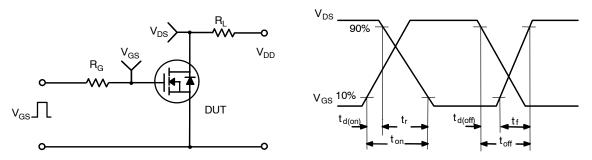


Figure 16. Resistive Switching Test Circuit & Waveforms

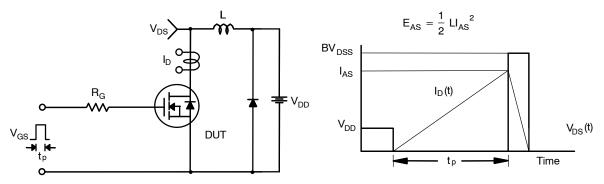


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms

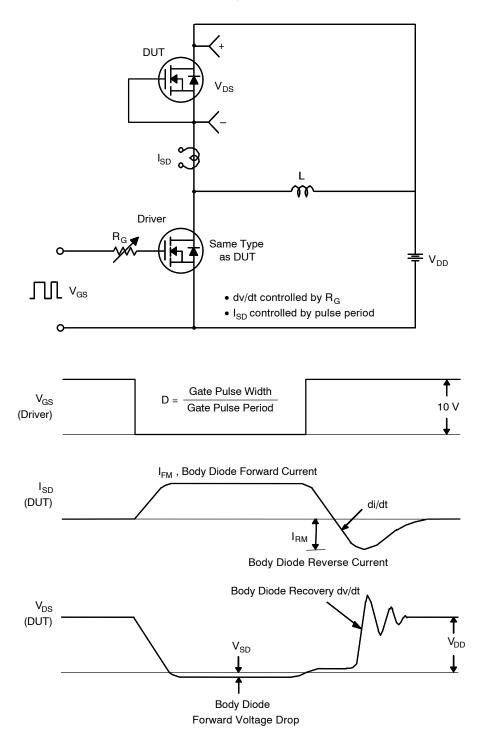
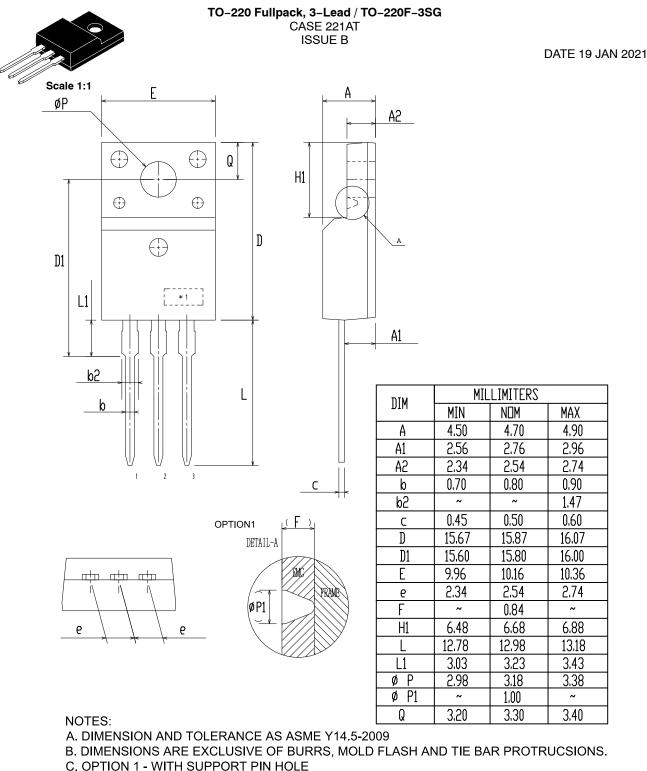


Figure 18. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET is a registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

onsemi

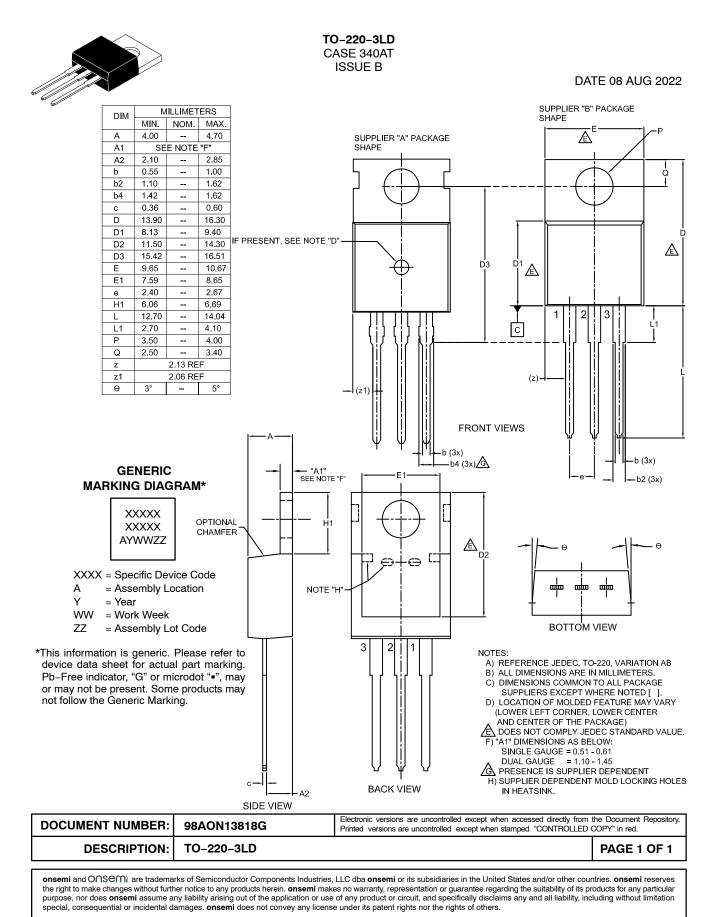


OPTION 2 - NO SUPPORT PIN HOLE

DOCUMENT NUMBER:	98AON67439E Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG		PAGE 1 OF 1	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.





onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>